

MOSFET – Power, Single N-Channel 60 V, 1.2 m Ω , 287 A

NVMFS5C604NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C604NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	60	V
Gate-to-Source Voltage	Э		V_{GS}	±20	٧
Continuous Drain		T _C = 25°C	I _D	287	Α
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		203	
Power Dissipation	State	T _C = 25°C	P_{D}	200	W
R _{θJC} (Note 1)		T _C = 100°C		100	
Continuous Drain		T _A = 25°C	I _D	40	Α
Current R _{0JA} (Notes 1, 2, 3)	Steady	T _A = 100°C		28	
Power Dissipation	State	T _A = 25°C	P_{D}	3.9	W
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.9	
Pulsed Drain Current	$T_A = 25$	°C, t _p = 10 μs	I _{DM}	900	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			I _S	203	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 22 A)			E _{AS}	776	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

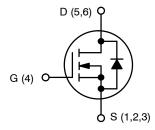
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

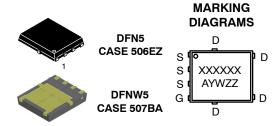
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.75	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
60 V	1.2 mΩ @ 10 V	007.4	
	1.7 mΩ @ 4.5 V	287 A	



N-CHANNEL MOSFET



XXXXXX = Specific Device Code

= Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D =	= 250 μA	60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				22.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, T	T _J = 25°C			10	
		V _{DS} = 60 V	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	= ±16 V			±100	nA
ON CHARACTERISTICS (Note 4)					-		
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μΑ	1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.93	1.2	_
		V _{GS} = 4.5 V	I _D = 50 A		1.25	1.7	mΩ
Forward Transconductance	9FS	V _{DS} = 15 V, I _E	_O = 50 A		180		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE				•		
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			8900		pF
Output Capacitance	C _{OSS}				3750		
Reverse Transfer Capacitance	C _{RSS}				40		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			52		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 30 V; I _D = 50 A			120		1
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			6.4		nC
Gate-to-Source Charge	Q _{GS}				21.4		
Gate-to-Drain Charge	Q_{GD}				12.7		
Plateau Voltage	V _{GP}				2.8		V
SWITCHING CHARACTERISTICS (Note 5)						
Turn-On Delay Time	t _{d(ON)}				21.8		
Rise Time	t _r	VGS = 4.5 V. Vr	ns = 30 V.		79.1		1
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 4.5 V, V_{D} I_{D} = 50 A, R_{G}	= 2.5 Ω		57.8		ns ns
Fall Time	t _f				81.3		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C		0.78	1.2	.,
		I _S = 50 A	T _J = 125°C		0.64		V
Reverse Recovery Time	t _{RR}		•		98		
Charge Time	ta	$V_{GS} = 0 \text{ V, dIS/dt}$	= 100 A/us.		45		ns
Discharge Time	t _b	$V_{GS} = 0 \text{ V, als/al} = 100 \text{ A/}\mu\text{s},$ $I_S = 50 \text{ A}$			53		1
Reverse Recovery Charge	Q _{RR}				190		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{4.} Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

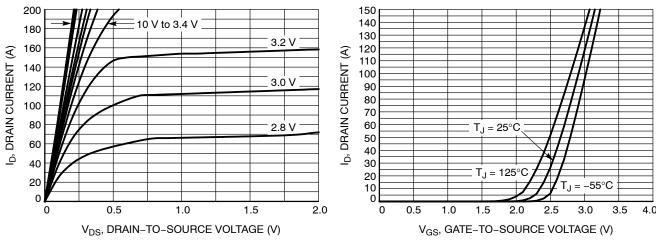


Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics

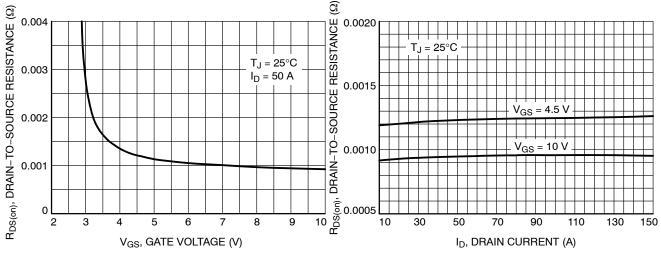


Figure 3. On-Resistance vs. Gate-to-Source Voltage

Figure 4. On-Resistance vs. Drain Current and Gate Voltage

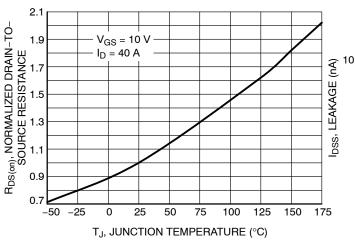


Figure 5. On–Resistance Variation with Temperature

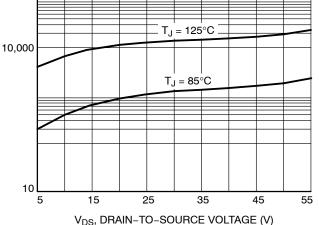
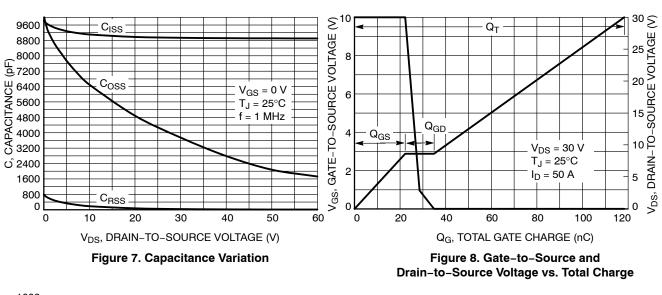


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS



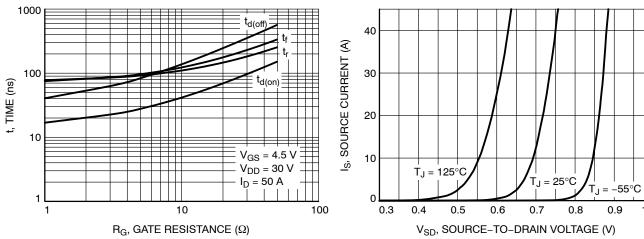


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 10. Diode Forward Voltage vs. Current

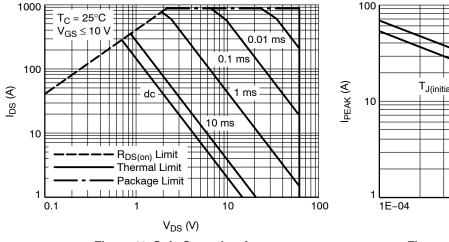


Figure 11. Safe Operating Area

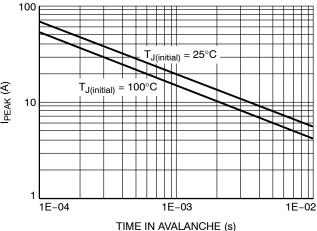


Figure 12. I_{PEAK} vs. Time in Avalanche

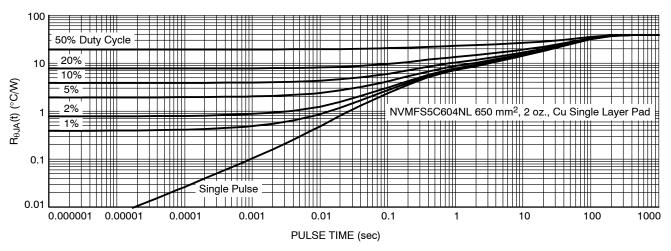


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

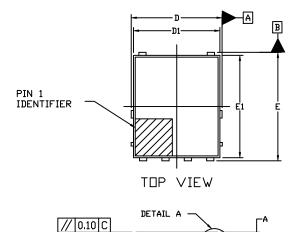
Device	Case	Marking	Package	Shipping [†]
NVMFS5C604NLT1G	506EZ	5C604L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C604NLWFT1G	507BA	604LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C604NLT3G	506EZ	5C604L	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS5C604NLWFT3G	507BA	604LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C604NLAFT1G	506EZ	5C604L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C604NLWFAFT1G	507BA	604LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

DFNW5 5x6 (FULL-CUT SO8FL WF)

CASE 507BA **ISSUE A**



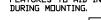
SIDE VIEW

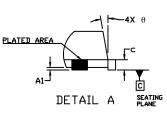


SEATING PLANE



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
 2. CONTROLLING DIMENSION: MILLIMETERS
 3. DIMENSIONS D1 AND E1 D0 NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.
 4. THIS PACKAGE CONTAINS WETTABLE FLANK DESIGN FEATURES TO A 41D IN FILLET FORMATION ON THE LEADS DURING MOUNTING.

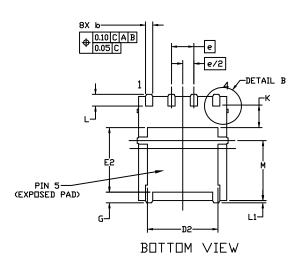




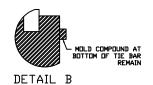
	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	0.90	1.00	1.10	
A1	0.00		0.05	
b	0.33	0.41	0.51	
c	0.23	0.28	0.33	
D	5.00	5.15	5.30	
D1	4.70	4.90	5.10	
D2	3.80	4.00	4.20	
Ε	6.00	6.15	6.30	
E1	5.70	5.90	6.10	
E2	3.45	3.65	3.85	
е		1.27 BSC		
G	0.51	0.575	0.71	
K	1.20	1.35	1.50	
L	0.51	0.575	0.71	
L1	0.150 REF			
М	3.00	3.40	3.80	
		_		

0°

12°



0.10 C



2X 0.4950 4.56
PACKAGE 2X 0.475 2x 1.53 3.20 4.53 4x 1.00 1 4x 0.75

RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

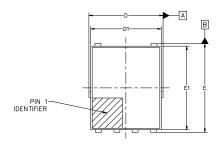




DFN5, 4.90 x 5.90 x 1.00, 1.27P CASE 506EZ **ISSUE B**

DATE 16 SEP 2024

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.



TOP VIEW

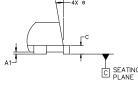
DETAIL "A"

SIDE VIEW

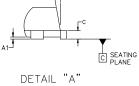
// 0.10 C

△ 0.10 C



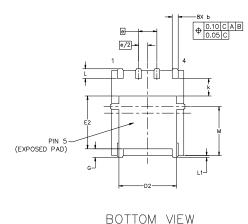


SCALED 2:1



PLANE	LI
	М
	Θ

MILLIMETERS					
DIM	MIN	NOM	MAX		
Α	0.90	1.00	1.10		
A1	0.00		0.05		
b	0.33	0.41	0.51		
С	0.23	0.28	0.33		
D	5.00	5.15	5.30		
D1	4.70	4.90	5.10		
D2	3.80	4.00	4.20		
Е	6.00	6.15	6.30		
E1	5.70	5.90	6.10		
E2	3.45	3.80	3.85		
е	1	.27 BSC)		
G	0.51	0.575	0.71		
k	1.10	1.20	1.40		
L	0.51	0.575	0.71		
L1	0	.125 RE	F		
М	3.00	3.40	3.80		
Θ	0.		12.		



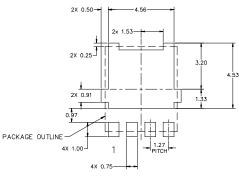
GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code = Assembly Location Α

Υ = Year W = Work Week ZZ = Lot Traceability

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON24855H	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	DFN5. 4.90 x 5.90 x 1.00. 1	.27P	PAGE 1 OF 1

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NVMFS5C604NLAFT3G NVMFS5C604NLWFAFT3G